

SR1045L THRU SR10100L

10 0A Surface Mount Schottky Barrier Rectifiers



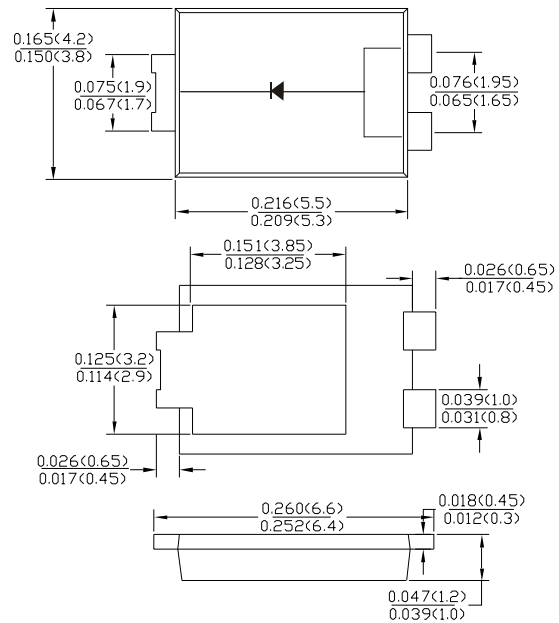
Features

- Schottky Barrier Chip
- High Thermal Reliability
- Patented Super Barrier Rectifier Technology
- High Forward Surge Capability
- Ultra Low Power Loss, High Efficiency
- Excellent High Temperature Stability
- Plastic material-UL flammability 94V-0

Mechanical Data

- Case: TO-277B, molded plastic
- Terminals: Plated Leads Solderable per MIL-STD-202, Method 208
- Polarity: Cathode Band
- Mounting Position: Any
- Marking: Type Number
- Lead Free: For RoHS/Lead Free Version

TO-277



dimensions in inches and (millimeters)

Maximum Ratings and Electrical Characteristics @T_A =25°C unless otherwise specified

Single Phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

Parameter	Symbol	SR1045L	SR1050L	SR1060L	SR1080L	SR10100L	Unit	
Peak Repetitive Reverse Voltage	V _{RRM}							
Working Peak Reverse Voltage	V _{RWM}	45	50	60	80	100	V	
DC blocking voltage	V _{DC}							
RMS Rectified Voltage	V _{R(RMS)}	28	35	42	56	70	V	
Average Rectified Output Current (Note1)	I _{F(AV)}	10						A
Non-Repetitive Peak Forward Surge 8.3ms Single Half Sine-Wave Superimposed on rated load (JEDEC Method) (Note2)	I _{FSM}	275						A
I ² t Rating for Fusing (t < 8.3ms)	I ² t	313.844						A ² s
Forward Voltage Drop T _A =25°C @ I _F =10A	V _{FM}	0.42	0.45	0.50	0.70		V	
Peak Reverse Current T _A =25°C At Rated DC Blocking Voltage T _A =100°C	I _R	0.3 15						mA
Typical Thermal Resistance Junction to Ambient	R _{θJA} R _{θJL}	80 15						°C/W
Operating junction temperature range	T _J	-55 to +150						°C
storage temperature range	T _{STG}	-55 to +150						°C

Note: 1. Valid Provided that are kept at ambient temperature at a distance of 9.5mm from the case.

2. Fr-4pcb. 2oz. Copper, minimum recommend pad layout .18.8mm×14.4. Anode pad dimensions 5.6mm×14.4mm.

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Fig.1 - Forward Current Derating Curve

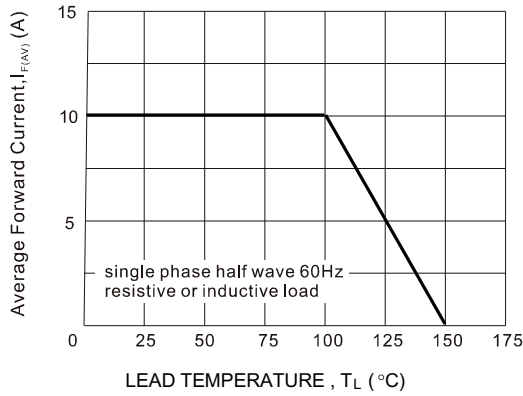


Fig.2 : Instantaneous Forward Voltage

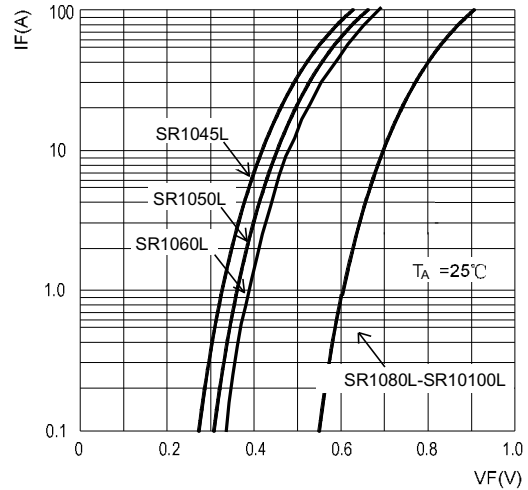


Fig.3: Surge Forward Current Capacity

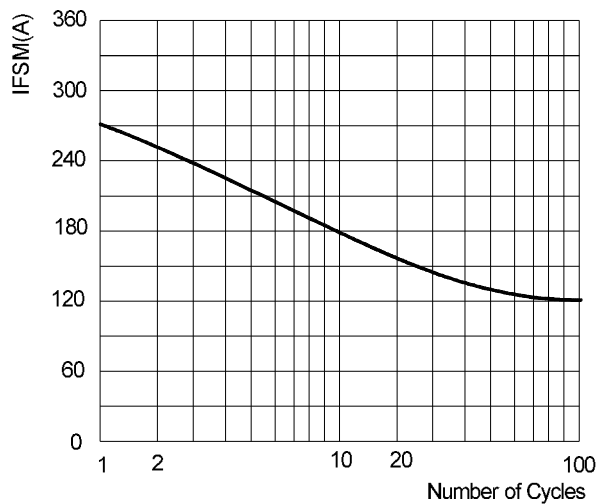


Fig.4: Typical Reverse Characteristics

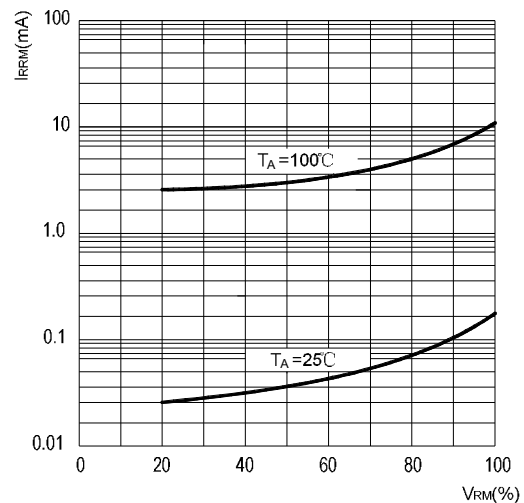


FIG.5 MOUNTING PAD LAYOUT

